CD	EC		CV.	TIO	PIN
ЭF		IFI	LA	IIU	כעוי

CUSTOMER . PTC

SAMPLE CODE . NSC1602WRP-GWA-I

MASS PRODUCTION CODE . NPC1602WRP-GWA-I

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 002

DRAWING NO. (Ver.) JLMD- NPC1602WRP-GWA-I_002

PACKAGING NO. (Ver.) : JPKG- NPC1602WRP-GWA-I_001

Customer Approved

Date:

POWERTIP 2015.05.22 JS RD APPROVED

Approved	Checked	Designer
閆偉	劉進	周志仙

Preliminary specification for design input

Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
05/15/2014	01	001	New Drawing		周志仙
04/15/2015	01	002	New Sample	-	周志仙
					>
		V			

Total: 30 Pages



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Appendix A : LCM drawing PKG drawing

Note: For detailed information please refer to IC data sheet: SITRONIX---ST7066U-0A



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	16*2 Characters
LCD Type	PBT , Negative , Transmissive
Driver Condition	LCD Module: 1/16 Duty , 1/5 Bias
Viewing Direction	6 O'clock
Weight	32.8g
Interface	6800-series 8-bit parallel
Driver IC	ST7066U
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web site:
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value			
Outline Dimension	80.0 (L) * 36.0 (W) *12.7 (H)	mm		
Viewing Area	66.0 (L) * 16.0 (W)	mm		
Active Area	56.2 (L) * 11.5 (W)	mm		
Character Size	2.95(L) * 5.55(W)	mm		
Character Pitch	3.55(L) * 5.95(W)	mm		

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

	J				
Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V_{DD}	-	-0.3	7.0	V
LCD Driver Supply Voltage	VLCD	-	VDD -10.0	VDD +0.3	
Input Voltage	Vin	-	-0.3	V _{DD} +0.3	V
Operating Temperature	Тор	-	-20	70	$^{\circ}\mathbb{C}$
Storage Temperature	Tst	-	-30	80	$^{\circ}\!\mathbb{C}$
Storage Humidity	H⊳	Ta<60 ℃	-	90	%RH

1.4 DC Electrical Characteristics

Ta = 25°C

					1u - 1	
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V_{DD}	-	4.5	5.0	5.5	V
"H" Input Voltage	ViH	-	0.7 VDD	-	VDD	V
"L" Input Voltage	VIL		-0.3	-	0.6	V
"H" Output Voltage	Vон	IOH=-0.1mA	3.9	-	VDD	V
"L" Output Voltage	Vol	IOL=0.1mA	-	-	0.4	V
Supply Current	I _{DD}	V _{DD} = 5.0 V ,V _O = 0.8 V	-	6	8	mA
		-20°C (VDD= 5.0 V)	1.0	0.8	0.6	
LCM Driver Voltage	Vo	25°C (VDD= 5.0 V)	1.0	0.8	0.6	V
		70°C (VDD= 5.0 V)	1.0	8.0	0.6	

NOTE: *1 The Maximum current display



1.5 Optical Characteristics

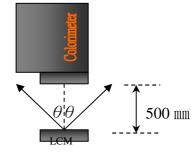
LCD Panel : 1/16 Duty , 1/5 Bias , V_{LCD} = 8.3 V , Ta =25 $^{\circ}$ C

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Response Time	Rise	tr	_	-	70	105	ms	Note 2
Nesponse fille	Fall	tf	-	-	30	45	1115	NOIG Z
	Тор	θ+		ı	60	-		
Viewing angle	Bottom	θ-	C- 2.0		60	-	Dog	Note 1
range	Left	θL	C <u>></u> 2.0	-	60	-	Deg.	Note i
	Right	θR		-	60	-		
Contrast Ra	tio	С	-	-	118	-	-	Note 3
Average Bright (with LCD)		IV		30	40	-	cd/m ²	
Color of CIE Coordinate (With LCD)		Х	IF= 40 mA	0.22	0.27	0.32		Note 4
		Υ		0.19	0.24	0.29	_	. 1010 1
Uniformity		∆B		70	-	-	%	

Note 4:

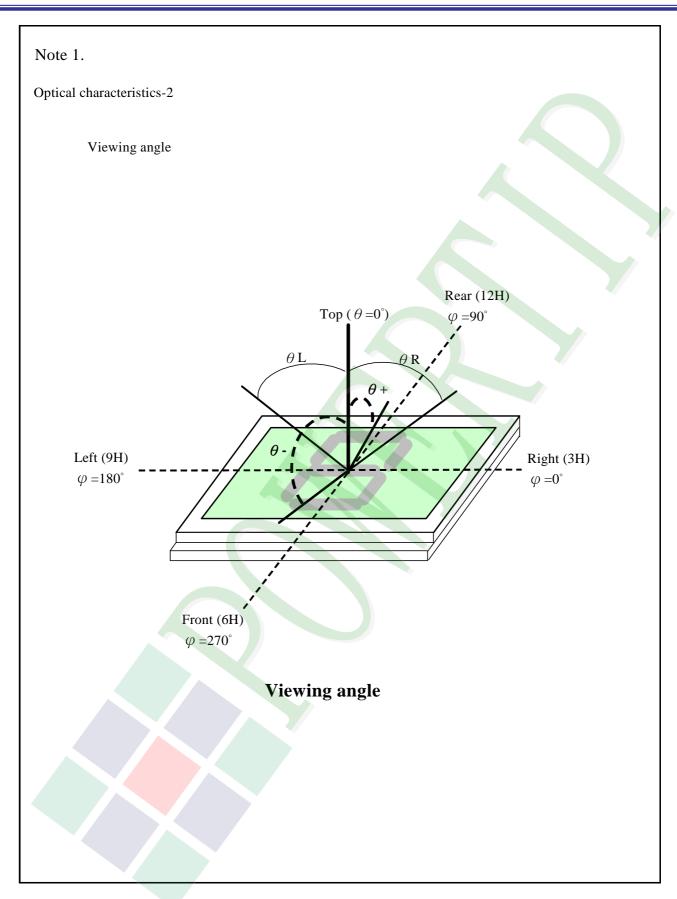
- $1 : \triangle B = B(min) / B(max) * 100\%$
- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25° C $\pm 5^{\circ}$ C $\to 60\pm 20\%$ R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b: Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ± 0.01 , Average Brightness $\pm 4\%$



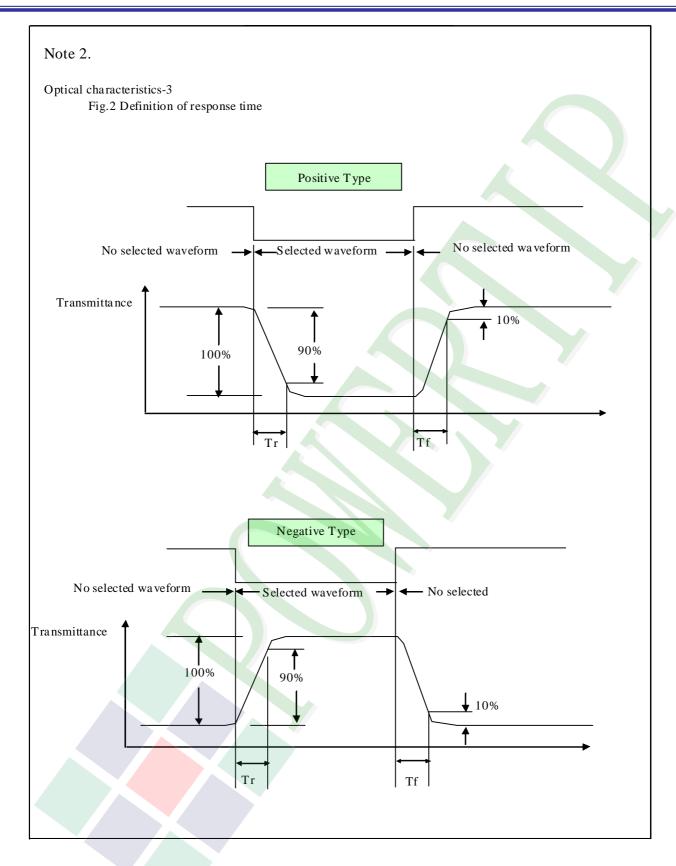


Colorimeter=BM-7 fast











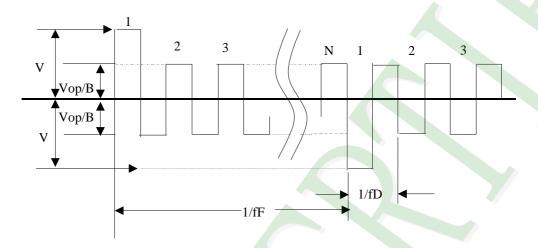
Electrical characteristics-2

※2 Drive waveform

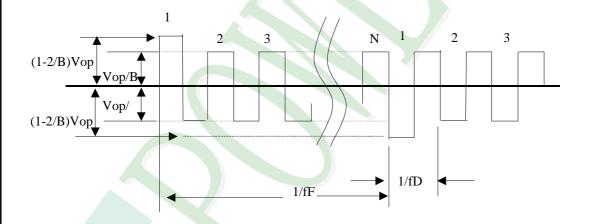
Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency

N: Duty

(1) Selected waveform



(2) Non-Selected wave form



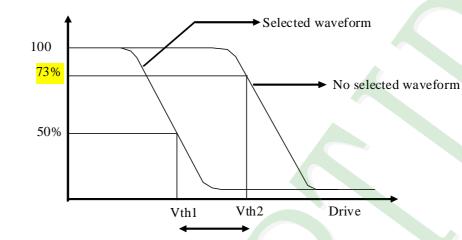
Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period



Note 3.: Definition of Vth

Transmittance



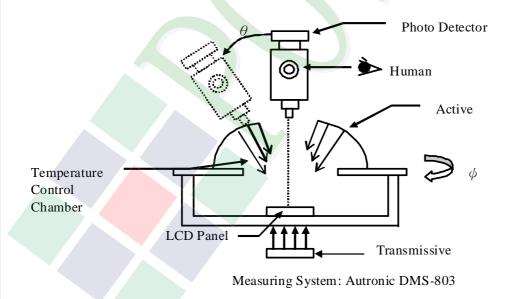
Active voltage range

	Vth1	Vth2
View direction	10°	40°
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System





1.6 Backlight Characteristics

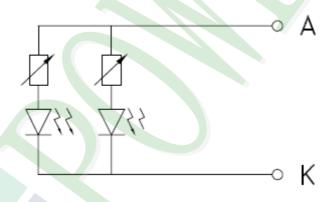
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°ℂ	-	40	mA
Reverse Voltage	VR	Ta =25°ℂ	-	5	V
Power Dissipation	PD	Ta =25°ℂ	- 🔨	132	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		3.0	3.3	3.6	V
Average Brightness (without LCD)	IV	IF= 40 mA	1200	1500	\ -	cd/m ²
CIE Color Coordinate	Χ		0.26	0.29	0.31	
(Without LCD)	Υ		0.26	0.29	0.31	-
Color			White			

Internal Circuit Diagram:





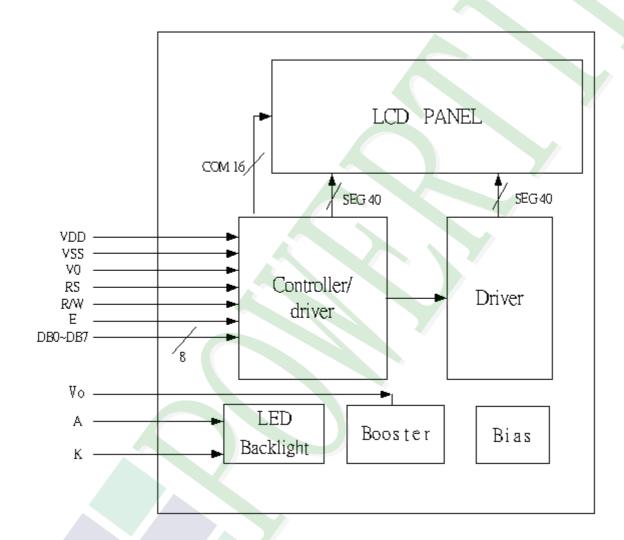
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





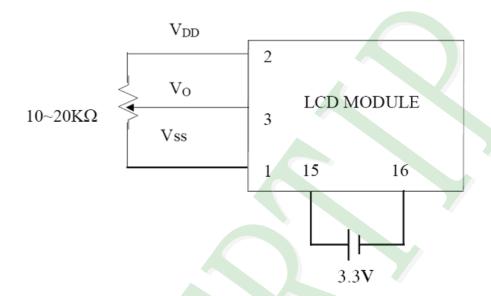
2.2 Interface Pin Description

Pin No.	Symbol	Signal Description
1	Vss	Power Supply (Vss=0)
2	V _{DD}	Power Supply (5V)
3	Vo	Operating voltage for LCD
4	RS	Register Selection input High = Data register Low = Instruction register (for write) Busy flag address counter (for read)
5	R/W	Read/Write signal input is used to select the read/write mode High = Read mode, Low = Write mode
6	Е	Start enable signal to read or write the data
7	DB0	
8	DB1	Four low order bi-directional three-state data bus lines. Use for data transfer between the MPU and the LCD module.
9	DB2	These four are not used during 4-bit operation.
10	DB3	These four are not used during 4-bit operation.
11	DB4	
12	DB5	Four high order bi-directional three-state data bus lines. Used for data transfer between the MPU and the LCD module.
13	DB6	DB7 can be used as a busy flag.
14	DB7	TDD/ Call be used as a busy liag.
15	A	LED+
16	K	LED-



2.2.1 Application Notes

Contrast Adjust



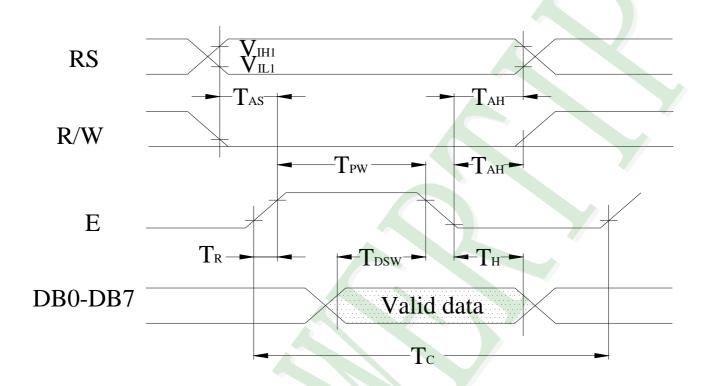
2.2.2 Refer Initial code

```
void initial()
{
    delay(40);
    write_com(0x01);
    delay(5);
    write_com(0x38);
    delay(5);
    write_com(0x0c);
    delay(5);
    write_com(0x06);
    delay(5);
```

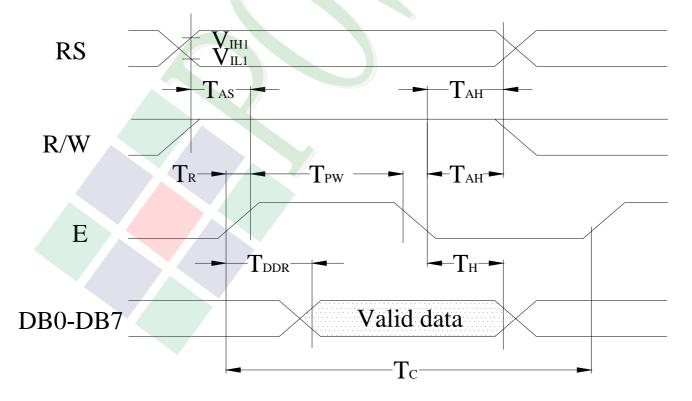


2.3 Timing Characteristics

Writing data from MPU to ST7066U



Reading data from ST7066U to MPU





Write Mode (Writing data from MPU to ST7066U)

 $(VDD = 5V,Ta=25^{\circ}C)$

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Tc	Enable Cycle Time	Pin E	1200	ı	1	ns
T _{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T _R , T _F	Enable Rise / Fall Time	Pin E	-	- (25	ns
Tas	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
Тан	Address Hold Time	Pins :RS,RW,E	10	1	-	ns
T _{DSW}	Data Setup Time	Pins:DB0~DB7	40	-	-	ns
Тн	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

Read Mode (Reading data from ST7066U to MPU)

 $(VDD = 5V,Ta=25^{\circ}C)$

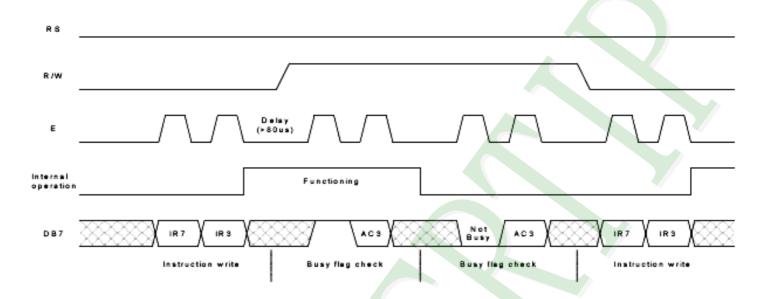
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Tc	Enable Cycle Time	Pin E	1200	1	ı	ns
T _{PW}	Enable Pulse Width	Pin E	140	-	ı	ns
T _R , T _F	Enable Rise / Fall Time	Pin E	-	-	25	ns
Tas	Address Setup Time	Pins: RS , RW,E	0	-	ı	ns
T _{AH}	Address Hold Time	Pins :RS,RW,E	10	ı	ı	ns
T_DDR	Data Setup Time	Pins:DB0~DB7	1	ı	100	ns
Тн	Data Hold Time	Pins:DB0~DB7	10	ı	-	ns





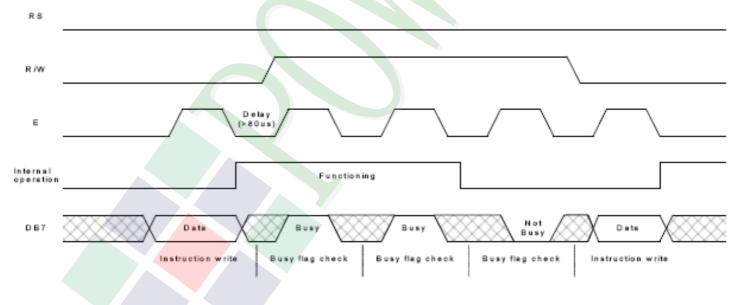
For 4-bit interface date, only four bus lines (DB4 to DB7) are used for transfer.

Example of busy flag check timing sequence



For 8-bit interface date, all eight bus lines (DB0 to DB7) are used .

Example of busy flag check timing sequence





2.4 Display Command

				l	Instru	ction	Code	Э				Description
Instructions		R/	DB	DB	DB	DB	DB	DB	DB	DB	Description	Time
	RS	W	7	6	5	4	3	2	1	0		(270KHz)
			-			-		_	-		Write "20H" to DDRAM, and set	
Clear	0	0	0	0	0	0	0	0	0	1	DDRAM address to "00H" from	1.52ms
Display										-	AC.	
											Set DDRAM address to "00H"	
											from AC and return cursor to it's	
Return	0	0	0	0	0	0	0	0	1	×	original position if shifted.	1.52ms
Home		J				0					The contents of DDRAM	1.021110
											are not changed.	
											Sets cursor move direction and	
Entry Mode											specifies display shift. These	
Set	0	0	0	0	0	0	0	1	I/D	S	operations are performed	37 µs
Set												
Dioploy								4			during data write and read .	
Display ON/OFF	0	0	0	0	0	0	1		C	В	D=1 : entire display on C=1 : cursor on	270
ON/OFF	U	U	U	U	U	U	1	D	С	Б		37 μ s
											B=1 : cursor position on	
Cursor or											Set cursor moving and display	
Display	0	0	0	0	0	1	S/C	R/L	×	×	shift control bit, and the	37 µs
Shift											the direction, without changing	
											of DDRAM data.	
Function						D .					DL: interface data is 8/4 bits	07
Set	0	0	0	0	1	DL	N	F	×	×	NL: number of line is 2/1	37 µs
											F: font size is 5×11/5×8	
Set					AC	AC	AC	AC	AC	AC	Set CGRAM address	
CGRAM	0	0	0	1	5	4	3	2	1	0	in address counter.	37 µs
Address								_	•		in dudi ees eedinen	
Set				AC	AC	AC	AC	AC	AC	AC	Set DDRAM address	
DDRAM	0	0	1	6	5	4	3	2	1	0	in address counter.	37 μ s
Address								_		U	in address counter.	
											Whether during internal	
Read Busy			В	AC	AC	AC	AC	AC	AC	AC	operation or not can be	
Flag and	0	1	F	6	5	4	3	2	1	0	known by reading BF.	0 µs
Address			1	U		7	3	_	'	U	The contents of address	
											counter can also be read.	



Write Data to RAM	1	0	D 7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	37 μ s
Read Data from RAM	1	1	D 7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	37µs

Note:

Be sure the ST7066U is not in the busy state (BF=0) before sending an instruction from the MPU to the ST7066.

If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself.

Before checking BF, be sure to wait at least 80us.. Do not keep "E" always "High" for checking BF Refer to Instruction Table for the list of each instruction execution time.



2.5 Character Pattern

NO.7066-0A

	000-		0010	0044	0100	0101	0.110	0111	1000	1001	1010	1011	1100	1101	1110	1111
67-64 63-60	0000	וטטטו	חוטט	ווטטו	0100	UIUI	DIID	ווע	1000	1001	1010	1011	1100	1101	11 10	1111
0000	CG RAM (1)															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	0															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
11 00	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

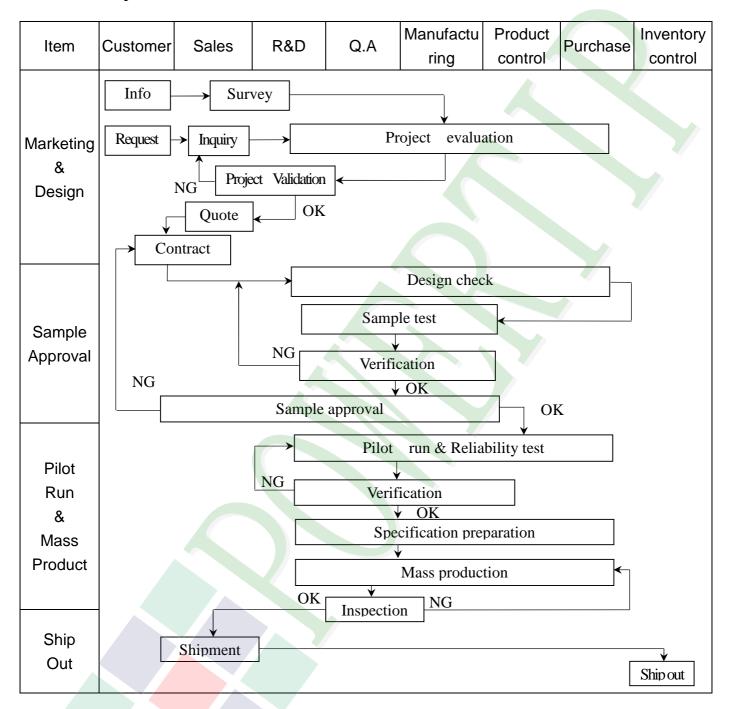
2.6 JUMPER

J1,J3,J5

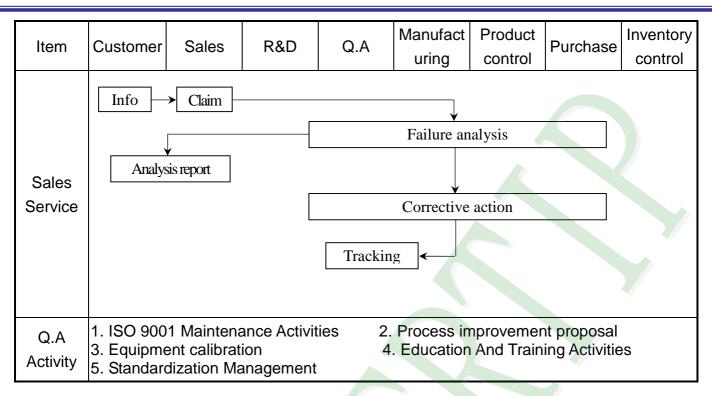


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

- ◆Scope: The document shall be applied to LCD Module for Monotype and Color STN(Ver. B01).
- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect: AQL: 1.5.
- **♦**OUT Going Defect Level : Sampling .
- ◆Manner of appearance test :
 - (1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.
 - (2). Standard of inspection: (Unit: mm)
 - (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (4). Definition of area . (Fig. 2)

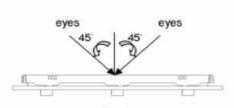


Fig.1

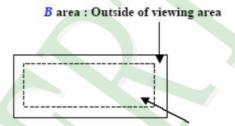


Fig. 2 A area: viewing area

♦ Specification:

NO	Item	Criterion	Level			
		1. 1 The part number is inconsistent with work order of Production.	Major			
01	Product condition	1. 2 Mixed production types.	Major			
		1.3 Assembled in inverse direction.	Major			
02	Quantity	. 1 The quantity is inconsistent with work order of production.				
03	Outline dimension	3. 1 Product dimension and structure must conform to Structure diagram.	Major			
		4. 1 Missing line character and icon.	Major			
		4. 2 No function or no display.	Major			
04	Electrical Testing	4, 3 Output data is error.	Major			
		4, 4 LCD viewing angle defect.	Major			
		4. 5 Current consumption exceeds product specifications.	Major			



◆Specification For Monotype and Color STN:

(Ver. B01)

NO	Item	C	riteri	on			Level		
	Black or white dot > scratch > contamination	4 white or black spots pr							
		5. 1. 2 Non-display:							
	Round type	Dimension	Acceptance (Q'ty) A area B area						
	Round type	(diameter : Φ)		A area	area				
	\rightarrow _X \leftarrow _{\(\psi\)}	$\Phi \leq 0.10$	Acce	ept no dense					
05 Φ=	Y	$0.10 < \Phi \leq 0.20$		3			N/		
	- - ★	$0.20 < \Phi \leq 0.30$		2		gnore	Minor		
	$\Phi = (x+y)/2$	Total quantity		4					
		5. 1. 3 Line type:							
	I in a tem a	Dimension		Accep	tanc	e (Q'ty)			
	Line type	Length (L) Width (W)		A area		B area			
	✓ / ¥ W	W ≤ (0. 03	Accept no de	nse				
	,	$L \le 3.0$ $0.03 < W \le 0$	0. 05	4		Ignore			
	L	$L \le 2.5$ $0.05 < W \le 0.$	075						
		W >0.	. 075	As	roun	d type			
				I .					
		Dimension		Acceptan	ce (Q	'ty)			
		(diameter : Φ)		A area		B area			
		$\Phi \leq 0.20$	Ac	cept no dense					
06	Polarizer	$0.20 < \Phi \leq 0.50$		3					
00	Bubble	$0.50 < \Phi \le 1.00$	2			Ignore	Minor		
		$\Phi > 1.00$		0					
		Total quantity		4	-				
				-					



♦Specification For Monotype and Color STN:

(Ver. B01)

NO	Item	Criterion		Level
		_	The width of crack. terminal length LCD side length	
		7.1 General glass chip: 7.1.1 Chip on panel surface and crack	between panels:	
		Z Z	Z X	
07	The crack of glass	SP	[NG]	Minor
		Seal width	Y	
		Z 🕽 . Y	z	
		≤ a Crack can't enter viewing area	≤1/2 t	
		≤ a Crack can't exceed the half of SP width.	1/2 t < Z ≤2 t	



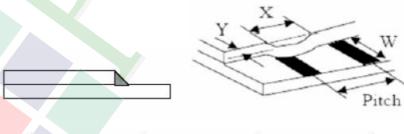
♦Spec	ification For Mo	notype and Color STN:	(Ver. B01)					
NO	Item	Criterion	Level					
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 7. 1. 2 Corner crack:						
		X Y Z						
		≤1/5 a Crack can't enter viewing area Z ≤ 1/2 t						
0.7	The crack of	$\leq 1/5$ a Crack can't exceed the half of SP width. $1/2$ t $<$ Z ≤ 2 t						
07	glass	7.2 Protrusion over terminal:	Minor					
		7.2.1 Chip on electrode pad:						
		W Y Z X Y Z						
		W X						
		X Y Z						
		Front \leq a \leq 1/2 W \leq t						
		Back Neglect						



◆Specification For Monotype and Color STN: (Ver. B01) NO Item Criterion Level Symbols: X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length 7.2.2 Non-conductive portion: \mathbf{X} Z The crack of 07 Minor glass ≤1/3 a \leq W ≦t ⊙ If the chipped area touches the ITO terminal, over 2/3 of

⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.

7. 2. 3 Glass remain:



X	Y	Z
≦ a	≤ 1/3 W	≦ t



◆Specification For Monotype and Color STN:

(Ver. B01)

Speci	incation For Mo	notype and Color STN:	Ver. B01)
NO	Item	Criterion	Level
		8. 1 Backlight can't work normally.	Major
08	Backlight elements	8. 2 Backlight doesn't light or color is wrong.	Major
		8. 3 Illumination source flickers when lit.	Major
		9. 1 Pin type must match type in specification sheet.	Major
		9. 2 No short circuits in components on PCB or FPC.	Major
09	General appearance	9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor
		9. 4 The folding and peeled off in polarizer are not acceptable.	Minor
		9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤1. 5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CONDITION				
1	High Temperature Storage Test	Keep in 80 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.				
2	Low Temperature Storage Test	Keep in -30 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.				
3	High Temperature / High Humidity Storage Test	Keep in +60 $^{\circ}$ C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)				
4	Temperature Cycling Storage Test	-30°C→ +25°C → 80°C → +25°C (30mins) (5mins) (30mins) (5mins) 10 Cycle Surrounding temperature, then storage at normal condition 4hrs.				
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance : 15°C ~35°C 2. Humidity relative : 30%~60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330 Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least				
6	Vibration Test (Packaged)	 (Tolerance if the output voltage indication: ±5%) Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration: 1.5 mm Each direction (X \ Y \ Z) duration for 2 Hrs 				
7	Drop Test (Packaged)	Packing Weight (Kg) Drop Height (cm) 0 ~ 45.4 122 45.4 ~ 90.8 76 90.8 ~ 454 61 Over 454 46 Drop Direction : 1 corner / 3 edges / 6 sides each 1 time				



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ±5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

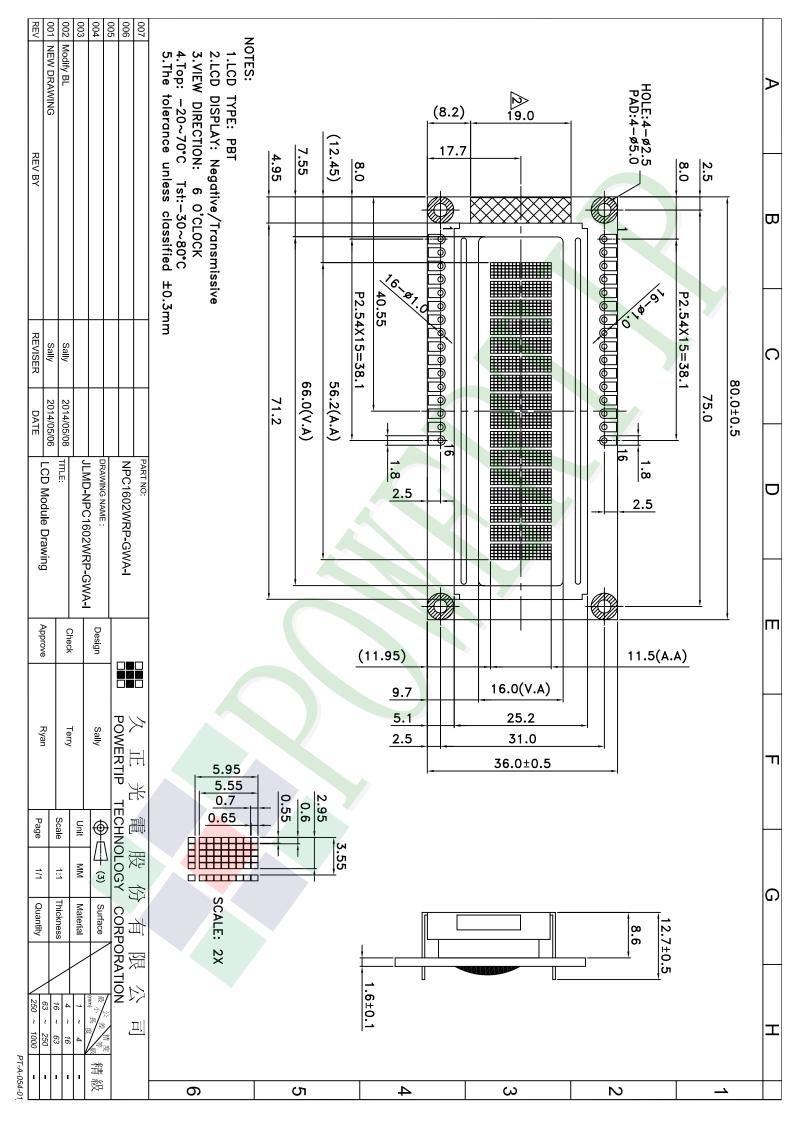
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 Documents NO. JPKG-NPC1602WRP-GWA-I Sally LCM Packaging Specifications Ryan Terry 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Dimensions (mm) 1Pcs Weight Total Weight Model Quantity 1 成品 (LCM) 80.0 X 36.0 X 12.7 NPC1602WRP-GWA-I 0.0328 468 15.444 2 靜電袋(1)Antistatic Bag BAG100100ARABA 100 X 100 0.0011 468 0.5148 3 295 X 47 X 3 A1-1隔板(3)A1-1 Partition 1.3104 0.0078 168 BX29500047BZBA 4 B1-1隔板(4)B1-1 Partition 245 X 47 X 3 0.0065 0.312 BX24500047BZBA 48 5 氣泡紙(5)Bubble Sheet BAG280240BWABA 280 X 240 0.006 24 0.144 6 C1內盒(6)Product Box 310 X 255 X 55 12. BX31025555AABA 0.13 1.56 7 外紙箱(7)Carton BX52732536CCBA 527 X 325 X 360 0.83 0.83 8 9 2.一整箱總重量 (Total LCD Weight in carton): 20.12 Kg±10% 3. 單箱數量規格表 (Packaging Specifications and Quantity): (1)Quantity Of Spacer: A1-1隔板 X 14 , B1-1隔板 X (2)Total LCM quantity in carton: quantity per box x no of boxes 12 468 (5) 氣泡紙 **Bubble Sheet** (1)靜電袋+(2)氣泡袋+LCM Antistatic Bag+Bubble Bag+LCM (4) B1-1隔板 B1-1 Partition (3) A1-1隔板 À1-1 Partition ᆥ (5) 氣泡紙 **Bubble Sheet** 仆 (7)外紙箱 Carton (6) C1内盒 Product Box 記 事 項 (REMARK) 4. Label Specifications: 5. LCM排放示意圖(前後間隔不放置): 5. LCM placed as figure showing: 依廠內標準作業 (First and last slot should be empty)

類 模組(LCM) X 1pcs.